

MOSFET – N-Channel, SUPERFET®

600 V, 47 A, 70 m Ω

FCA47N60, FCA47N60-F109

Description

SUPERFET MOSFET is **onsemi**'s first generation of high voltage super–junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on–resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. Consequently, SUPERFET MOSFET is very suitable for the switching power applications such as PFC, server/telecom power, FPD TV power, ATX power and industrial power applications.

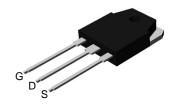
Features

- 650 V @ $T_J = 150$ °C
- Typ. $R_{DS(on)} = 58 \text{ m}\Omega$
- Ultra Low Gate Charge (Typ. Q_g = 210 nC)
- Low Effective Output Capacitance (Typ. C_{oss(eff.)} = 420 pF)
- 100% Avalanche Tested

Applications

- Solar Inverter
- AC-DC Power Supply

V _{DSS}	R _{DS(on)} MAX	I _D MAX	
600 V	70 mΩ @ 10 V	47 A	



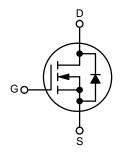
TO-3P-3LD / EIAJ SC-65, ISOLATED CASE 340BZ

MARKING DIAGRAM



FCA47N60 = Specific Device Code
A = Assembly Location
YWW = Date Code (Year & Week)
ZZ = Assembly Lot

N-CHANNEL MOSFET



ORDERING INFORMATION

Part Number	Package	Shipping
FCA47N60		450 Units / Tube
FCA47N60-F109	(Pb-Free)	450 Units / Tube

ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter		FCA47N60 FCA47N60-F10		9 Unit	
V_{DSS}	Drain-Source Voltage			600	V	
I _D	Drain Current	- Continuous (T _C = 25°C)		47	Α	
		– Continuous (T _C = 100°C)		29.7		
I _{DM}	Drain Current	- Pulsed (Note 1)		141	Α	
V _{GSS}	Gate-Source Voltage			±30		
E _{AS}	Single Pulsed Avalanche Energy (Note 2)		1800		mJ	
I _{AR}	Avalanche Current (Note 1)			47		
E _{AR}	Repetitive Avalanche Energy (Note 1)			41.7	mJ	
dv/dt	Peak Diode Recovery dv/dt (Note 3)			4.5	V/ns	
P_{D}	Power Dissipation	(T _C = 25°C)		417	W	
		– Derate above 25°C		3.33	W/°C	
T _J , T _{STG}	Operating and Storage Temperature Range		-5	5 to +150	°C	
TL	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds			300	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Repetitive Rating: Pulse—width limited by maximum junction temperature.

- 2. $I_{AS} = 18 \text{ A}$, $R_G = 25 \Omega$, starting $T_J = 25^{\circ}\text{C}$. 3. $I_{SD} \le 47 \text{ A}$, $di/dt \le 200 \text{ A/µs}$, $V_{DD} = 380 \text{ V}$, starting $T_J = 25^{\circ}\text{C}$.

THERMAL CHARACTERISTICS

Symbol	Parameter	Тур	Max	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case, Max.	-	0.3	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient, Max.	-	41.7	°C/W

ELECTRICAL CHARACTERISTICS ($T_C = 25^{\circ}C$ unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
OFF CHAR	ACTERISTICS			1	ı	I
BV _{DSS} Drain-Source Breakdown Voltage		$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}, T_J = 25^{\circ}\text{C}$	600	-	_	V
		V _{GS} = 0 V, I _D = 250 μA, T _J = 150°C	-	650	-	
$\Delta BV_{DSS} / \Delta T_{J}$	Breakdown Voltage Temperature Coefficient	I_D = 250 μA, Referenced to 25°C	-	0.6	_	V/°C
BV _{DS}	Drain-Source Avalanche Breakdown Voltage	V _{GS} = 0 V, I _D = 47 A	-	700	-	V
I _{DSS} Zero Gate Voltage Drain Cu	Zero Gate Voltage Drain Current	V _{DS} = 600 V, V _{GS} = 0 V	-	-	10	μΑ
		V _{DS} = 480 V, T _C = 125°C	-	-	100	
I _{GSSF}	Gate-Body Leakage Current, Forward	V _{GS} = 30 V, V _{DS} = 0 V	-	-	100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V _{GS} = -30 V, V _{DS} = 0 V	_	_	-100	nA
ON CHARA	CTERISTICS				•	1
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	3.0	-	5.0	V
R _{DS(on)}	Static Drain–Source On–Resistance	V _{GS} = 10 V, I _D = 23.5 A	-	0.058	0.07	Ω
9FS	Forward Transconductance	V _{DS} = 20 V, I _D = 23.5 A	_	40	_	S
DYNAMIC C	CHARACTERISTICS				•	1
C _{iss}	Input Capacitance	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V}, f = 1.0 \text{ MHz}$	_	5900	8000	pF
C _{oss}	Output Capacitance		-	3200	4200	pF
C _{rss}	Reverse Transfer Capacitance	1	-	250	-	pF
C _{oss}	Output Capacitance	V _{DS} = 480 V, V _{GS} = 0 V, f = 1.0 MHz	-	160	_	pF
Coss eff.	Effective Output Capacitance	V _{DS} = 0 to 400 V, V _{GS} = 0 V	-	420	_	pF
SWITCHING	CHARACTERISTICS				•	1
t _{d(on)}	Turn-On Delay Time	$V_{DD} = 300 \text{ V}, I_{D} = 47 \text{ A}, R_{G} = 25 \Omega$	_	185	430	ns
t _r	Turn-On Rise Time	(Note 4)	-	210	450	ns
t _{d(off)}	Turn-Off Delay Time	1	_	520	1100	ns
t _f	Turn-Off Fall Time	1	-	75	160	ns
Qg	Total Gate Charge	V _{DS} = 480 V, I _D = 47 A, V _{GS} = 10 V	-	210	270	nC
Q _{gs}	Gate-Source Charge	(Note 4)	_	38	_	nC
Q _{gd}	Gate-Drain Charge	1	_	110	_	nC
	JRCE DIODE CHARACTERISTICS AND I	MAXIMUM RATINGS			ı	I
I _S	Maximum Continuous Drain-Source Diode Forward Current		_	_	47	Α
I _{SM}	Maximum Pulsed Drain-Source Diode Forward Current		_	_	141	Α
V _{SD}	Drain-Source Diode Forward Voltage	V _{GS} = 0 V, I _S = 47 A	-	_	1.4	V
t _{rr}	Reverse Recovery Time	$V_{GS} = 0 \text{ V}, I_{S} = 47 \text{ A}, dI_{F}/dt = 100 \text{ A/}\mu\text{s}$	_	590	_	ns
		(Note 4)		1	-	μC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. Essentially independent of operating temperature typical characteristics.

TYPICAL CHARACTERISTICS

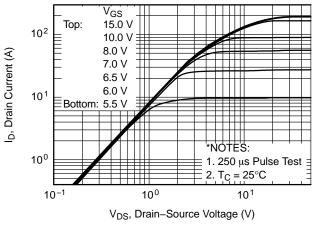


Figure 1. On-Region Characteristics

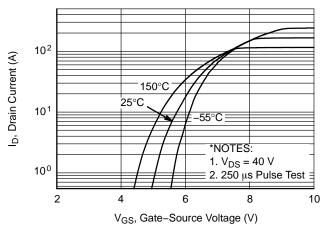


Figure 2. Transfer Characteristics

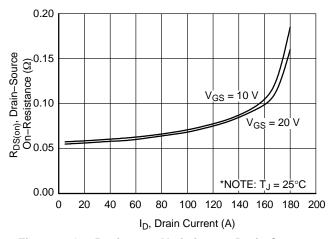


Figure 3. On–Resistance Variation vs. Drain Current and Gate Voltage

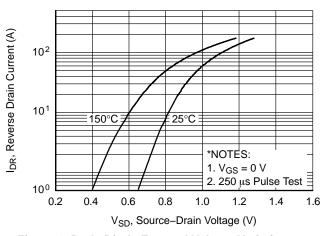


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

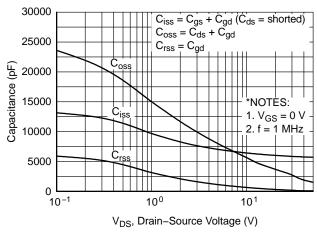


Figure 5. Capacitance Characteristics

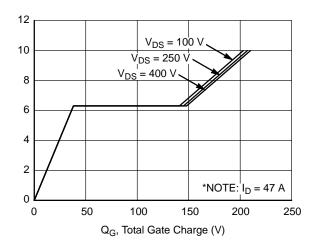
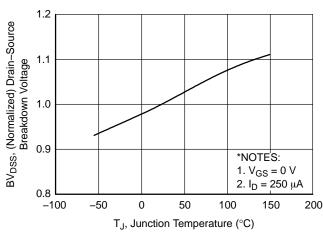


Figure 6. Gate Charge Characteristics

V_{GS}, Gate-Source Voltage (V)

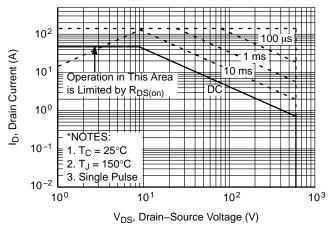
TYPICAL CHARACTERISTICS (CONTINUED)



3.0 R_{DS(on)}, (Normalized) Drain-Source 2.5 On-Resistance 2.0 1.5 1.0 *NOTES: 0.5 1. $V_{GS} = 10 \text{ V}$ 2. $I_D = 47 A$ 0.0 200 -100 -50 50 100 150 T_J, Junction Temperature (°C)

Figure 7. Breakdown Voltage Variation vs. Temperature

Figure 8. On-Resistance Variation vs. Temperature



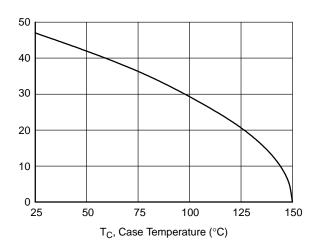
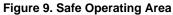
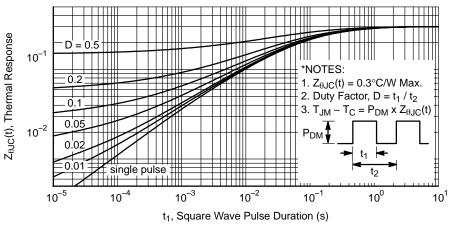


Figure 10. Maximum Drain Current vs.

Case Temperature





ID, Drain Current (A)

Figure 11. Transient Thermal Response Curve

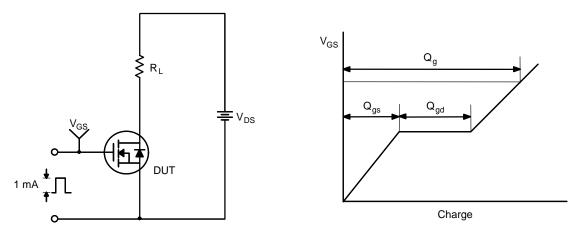


Figure 12. Gate Charge Test Circuit & Waveform

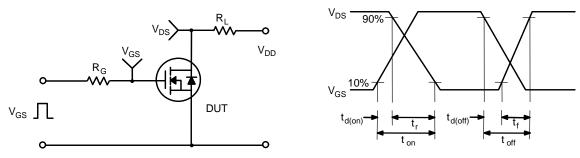


Figure 13. Resistive Switching Test Circuit & Waveforms

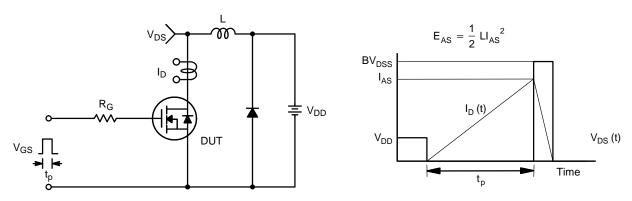
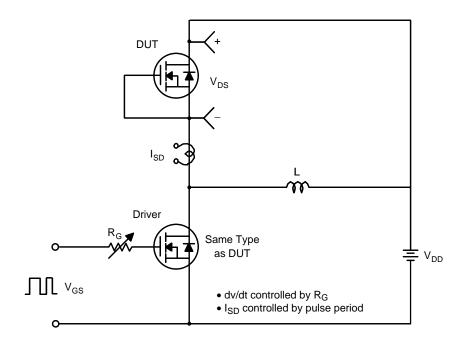


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms



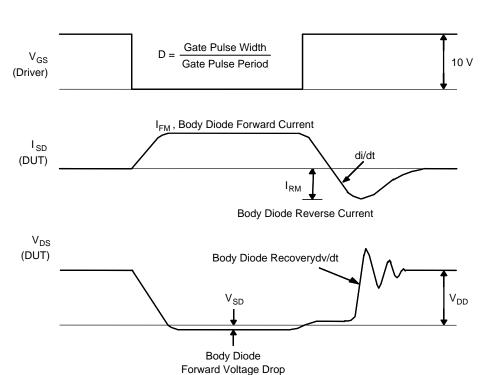


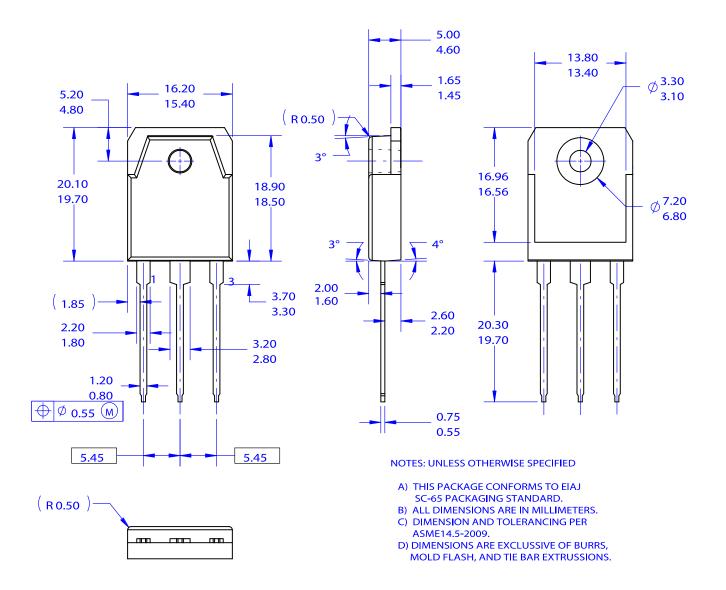
Figure 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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TO-3P-3LD / EIAJ SC-65, ISOLATED CASE 340BZ ISSUE O

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